<b>PCN Num</b>	201	20130926000				PCN Date:		09/27/2013		
Title: Qualification of NFME as Additional Assembly/Test Site for TPD4S009DBVR dev								VR device		
Customer Contact:			<u>Manager</u>	Phon	one: +1(214)480-6037		Dept:	t: Quality Services		
Proposed 1 <sup>st</sup> Ship Date		e:	12/27/20	/27/2013 Estimated Sample Availability:		Date Provided at Sample request				
Change T	уре:									
Assembly Site			Assembly Process		Assembly Materials					
☐ Test Site			Packing/Shipping/Labeling		Test Process					
	PCN Details									

## CN Details

# **Description of Change:**

Qualification of NFME as additional assembly and test site for TPD4S009DBVR device. Assembly differences are shown in the following table:

	HNC	NFME
Wire	500072T (Au)	W-15 (Cu)
Mold Compound	450228 (Sumitomo)	R-17 (Hitachi)
Lead Finish	NiPdAu	Matte Sn

Upon expiration of this PCN, TI will combine lead free solutions in a single standard part number, for example; <u>TPD4S009DBVR</u> - can ship with both Matte Sn and NiPdAu.

Customers may specify NiPdAu finish by ordering the part with the G4 suffix, TPD4S009DBVRG4.

Test coverage, insertions, conditions will remain consistent with current testing and verified with test MO.

### **Reason for Change:**

Continuity of Supply

- 1) To align with world technology trends and use wiring with enhanced mechanical and electrical properties
- 2) Maximize flexibility within our Assembly/Test production sites.
- 3) Cu is easier to obtain and stock

#### Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):

None

### Changes to product identification resulting from this PCN:

Assembly Site		
HNC (Hana China)	Assembly Site Origin (22L)	ASO: CHS
NFME (Nantong Fujitsu Micro-Electronics)	Assembly Site Origin (22L)	ASO: NFM

Sample product shipping label (not actual product label)



### **Device Marking**



1ST DIGIT = DEVICE FAMILY

2ND/3RD DIGIT = DEVICE FUNCTION CODE

4TH DIGIT = WAFER FAB/ASSEMBLY SITE CODE \*\*\*\* = BINARY DATE PER TI DWG 4205087

O = PIN 1 INDICATOR

## **Topside Device marking:**

Assembly site code for HNC = 9 Assembly site code for NFME = E

#### **Product Affected:**

TPD4S009DBVR

## **Qualification Data**

This qualification has been specifically developed for the validation of this change. The qualification data validates that the proposed change meets the applicable released technical specifications.

## Qual Vehicle: TPD4S009DBVR (MSL1-260C)

Package Construction Details								
Assembly Site:	NFME	Mold Compound:	R-17					
# Pins-Designator, Family:	6-DBV, SOT-23	Mount Compound:	A-03					
Lead Finish, Base	Matte Sn, Cu	Bond Wire:	1.0 Mil Dia. Cu					
One lift and the Diagram of Table 19 and 19								

Qualification: $\square$ Plan $\boxtimes$ I	est Results			
Reliability Test	Conditions	Sam	ple Size /	' Fail
		Lot# 1	Lot# 2	Lot# 3
** Temperature Cycle	-65/150C (1000 cycles)	77/0	77/0	77/0
Ball Bond Shear	76 ball bonds, min. 5 units	78/0	78/0	78/0
Bond Pull	76 ball bonds, min. 5 units	78/0	78/0	78/0
X-ray	(Top Side Only)	5/0	5/0	5/0

Manufacturability (MQ) - \*\*- Preconditioning sequence: Level 1-260C.

## Reference Qualification: SOT-23 Package at NFME

# Qualification Data: Approved 05/14/2013

This qualification has been developed for the validation of this change. The qualification data validates that the proposed change meets the applicable released technical specifications.

## Qual Vehicle 1: TL432ACDBVR

Qualitational 1 12 to 2 to 2 to 1							
Package Construction Details							
Assembly Site:	NFME	Mold Compound:	R-17				
# Pins-Designator, Family:	5-DBV, SOT-23	Mount Compound:	A-03				
Lead frame (Finish, Base):	Matte Sn, Cu	Bond Wire:	1.0 Mil Dia., Cu				

Qualification:	Plan	🔀 Test	Resu	lts
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Deliability Teet	Conditions	Sample Size/Fail			
Reliability Test	Conditions	Lot# 1	Lot# 2	Lot# 3	
Electrical Characterization	-	Pass	-	-	
Life Test	150C(300 Hrs)	77/0	77/0	-	
**Autoclave	121C (192 Hrs)	77/0	77/0	77/0	
**Thermal Shock	-65C/+150C (500 Cyc)	77/0	77/0	-	
**Temperature Cycle	-65C/+150C (1000 Cyc)	77/0	77/0	77/0	
**Unbiased HAST	130C/85%RH (96 Hrs)	77/0	77/0	77/0	
**Biased HAST	130C/85%RH (192 Hrs)	77/0	77/0	-	

Pass

Pass

**Pass** 

**High Temp Storage Bake		170C (600Hrs)		77/0		77/0	77/0
Flammability (UL 94V-0)		(UL 94V-0)		5/0		5/0	=
Flammability (UL-1694)		(UL-1694)			)	5/0	=
Flammability (IEC 695-2-2)		(IEC 695-2-2)	,		)	5/0	-
Solderability		Steam age, 8 hou	ırs; PB-Free solder	22/	0	22/0	ı
Salt Atmosphere		-		22/	0	22/0	-
X-ray		(top side only)		5/0	)	5/0	5/0
Manufacturability (Assembly	<b>/</b> )	(per mfg. Site s	pecification)	Pas	s	Pass	Pass
Moisture Sensitivity		L1-260C		12/	0	12/0	12/0
Notes **- Preconditioning	sequ	ence: Level 1-260	OC.				
	(	Qual Vehicle 2 :	TS321IDBVR				
		Package Constr	uction Details				
Assembly Site:	NFM	E	Mold Comp	ound:	R-1	L7	
# Pins-Designator, Family:	5-DB	V, SOT-23	Mount Comp	ound:	A-0	)3	
Lead frame (Finish, Base):	Matte	e Sn, Cu	Bond	Wire: 1.0 Mil Dia., Cu		J	
Qualification:  Plan	<b>1</b>	Test Results					
		Conditions		Sample Size/Fail			
Reliability Test				Lot#		Lot# 2	Lot# 3
El		_				LUC# Z	
Electrical Characterization Life Test				Pas		-	-
		150C(300 Hrs)		77/			
**Autoclave		121C (192 Hrs)		77/		77/0 -	77/0
**Thermal Shock		-65C/+150C (500 Cyc) -65C/+150C (1000 Cyc)		77/			77/0
**Temperature Cycle				77/		77/0	77/0
**Unbiased HAST		130C/85%RH (96 Hrs)		77/		77/0 -	77/0 -
**Biased HAST		130C/85%RH (192 Hrs)		77/			
**High Temp Storage Bake		170C (600Hrs)		77/0		77/0	77/0 -
Flammability (UL 94V-0)		(UL 94V-0)		5/0		-	-
Flammability (UL-1694)		(UL-1694)		5/0		-	-
Flammability (IEC 695-2-2)		(IEC 695-2-2)		5/0		-	-
Solderability		Steam age, 8 hours; PB-Free solder		22/0		-	-
Salt Atmosphere		(top side subs)		22/ 5/0		- 5/0	5/0
X-ray		(top side only)	n a aifi anti a m			•	
Manufacturability (Assembly	<u>')</u>	(per mfg. Site s	pecification)	Pas		Pass	Pass
Moisture Sensitivity		L1-260C		12/	U	12/0	12/0
Notes **- Preconditioning sequence: Level 1-260C.							

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com